## Old Company Name in Catalogs and Other Documents

On April 1<sup>st</sup>, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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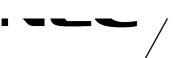


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### DATA SHEET





# PHOTOCOUPLER PS2705-1

### HIGH ISOLATION VOLTAGE AC INPUT RESPONSE TYPE SOP MULTI PHOTOCOUPLER

-NEPOC Series-

### **DESCRIPTION**

The PS2705-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor.

This package is SOP (Small Outline Package) type and has shield effect to cut off ambient light. It is designed for high density mounting applications.

### **FEATURES**

- · AC input response
- High isolation voltage (BV = 3 750 Vr.m.s.)
- High current transfer ratio (CTR = 100% TYP.)
- · SOP (Small Outline Package) type
- High-speed switching ( $t_r = 3 \mu s TYP.$ ,  $t_f = 5 \mu s TYP.$ )
- · Ordering number of taping product: PS2705-1-F3, F4
- Safety standards
  - UL approved: File No. E72422
  - BSI approved: File No. 8219/8220
  - CSA approved: File No. CA 101391
  - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

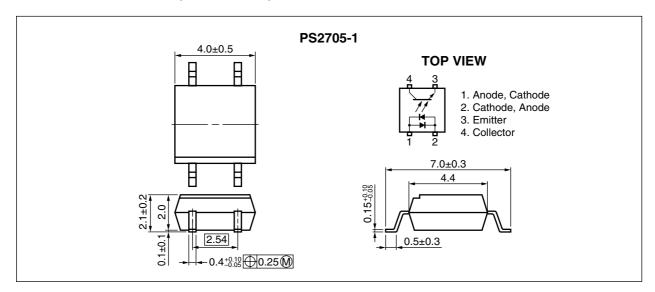
### **APPLICATIONS**

- · Hybrid IC
- Telephone/FAX
- FA/OA equipment
- Programmable logic controllers
- Power supply

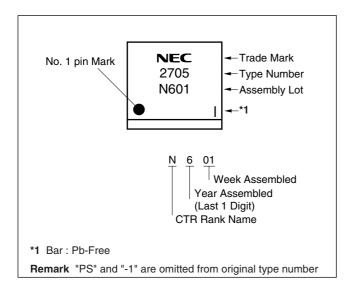
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### **PACKAGE DIMENSIONS (in millimeters)**



### **★ MARKING EXAMPLE**



2



### **★ ORDERING INFORMATION**

| Part Number   | Order Number    | Solder Plating<br>Specification | Packing Style                | Safety Standard<br>Approval | Application Part<br>Number   ¹ |
|---------------|-----------------|---------------------------------|------------------------------|-----------------------------|--------------------------------|
| PS2705-1      | PS2705-1-A      | Pb-Free                         | Magazine case 100 pcs        | Standard products           | PS2705-1                       |
| PS2705-1-F3   | PS2705-1-F3-A   |                                 | Embossed Tape 3 500 pcs/reel | (UL, BSI, CSA               |                                |
| PS2705-1-F4   | PS2705-1-F4-A   |                                 |                              | approved)                   |                                |
| PS2705-1-V    | PS2705-1-V-A    |                                 | Magazine case 100 pcs        | DIN EN60747-5-2             |                                |
| PS2705-1-V-F3 | PS2705-1-V-F3-A |                                 | Embossed Tape 3 500 pcs/reel | (VDE0884 Part2)             |                                |
| PS2705-1-V-F4 | PS2705-1-V-F4-A |                                 |                              | Approved (Option)           |                                |

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

3



### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

| Parameter                       |                                   | Symbol           | Ratings     | Unit    |
|---------------------------------|-----------------------------------|------------------|-------------|---------|
| Diode                           | Forward Current (DC)              | lF               | ± 50        | mA      |
|                                 | Power Dissipation Derating        | ⊿P₀/°C           | 0.8         | mW/°C   |
|                                 | Power Dissipation                 | Po               | 80          | mW      |
|                                 | Peak Forward Current <sup>™</sup> | IFP              | ± 1         | Α       |
| Transistor                      | Collector to Emitter Voltage      | Vceo             | 40          | V       |
|                                 | Emitter to Collector Voltage      | VECO             | 6           | V       |
|                                 | Collector Current                 | Ic               | 80          | mA      |
|                                 | Power Dissipation Derating        | ⊿Pc/°C           | 1.5         | mW/°C   |
|                                 | Power Dissipation                 | Pc               | 150         | mW      |
| Isolation Voltage <sup>*2</sup> |                                   | BV               | 3 750       | Vr.m.s. |
| Operating Ambient Temperature   |                                   | TA               | -55 to +100 | °C      |
| Storage Temperature             |                                   | T <sub>stg</sub> | -55 to +150 | °C      |

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1%

<sup>\*2</sup> AC voltage for 1 minute at  $T_A = 25^{\circ}C$ , RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.



### **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

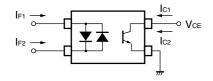
|            | Parameter                            | Symbol             | Conditions  | MIN.             | TYP. | MAX. | Unit |
|------------|--------------------------------------|--------------------|---|------------------|------|------|------|
| Diode      | Forward Voltage                      | VF                 | $I_F = \pm 5 \text{ mA}$  |                  | 1.1  | 1.4  | V    |
|            | Terminal Capacitance                 | Ct                 | V = 0 V, f = 1 MHz  |                  | 60   |      | pF   |
| Transistor | Collector to Emitter Dark<br>Current | ICEO               | IF = 0 mA, VCE = 40 V   |                  |      | 100  | nA   |
| Coupled    | Current Transfer Ratio               | CTR                | $I_F = \pm 5 \text{ mA}, V_{CE} = 5 \text{ V}$                          | 50               | 100  | 300  | %    |
|            | CTR Ratio <sup>2</sup>               | CTR <sub>1</sub> / | $I_F = \pm 5 \text{ mA}, V_{CE} = 5 \text{ V}$                          | 0.3              | 1.0  | 3.0  |      |
|            | Collector Saturation<br>Voltage      | VCE (sat)          | $I_F = \pm 10 \text{ mA}, I_C = 2 \text{ mA}$                           |                  |      | 0.3  | V    |
|            | Isolation Resistance                 | Ri-o               | Vi-o = 1 kVpc   | 10 <sup>11</sup> |      |      | Ω    |
|            | Isolation Capacitance                | C <sub>I-O</sub>   | V = 0 V, f = 1 MHz  |                  | 0.4  |      | pF   |
|            | Rise Time *3                         | tr                 | $Vcc = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$ |                  | 3    |      | μs   |
|            | Fall Time *3                         | tr                 |   |                  | 5    |      |      |

### \*1 CTR rank

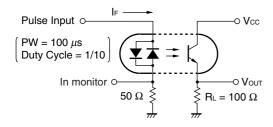
M: 50 to 150 (%) L: 100 to 300 (%)

N: 50 to 300 (%)

\*2 CTR<sub>1</sub> =  $I_{C1}/I_{F1}$ , CTR<sub>2</sub> =  $I_{C2}/I_{F2}$ 

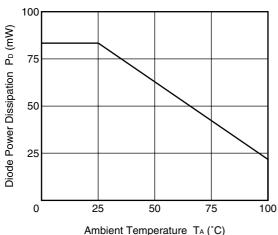


### \*3 Test circuit for switching time

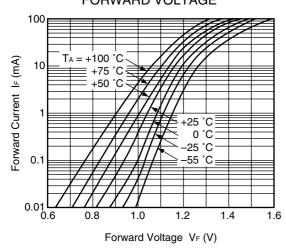


### TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

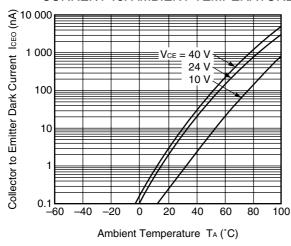




### FORWARD CURRENT vs. FORWARD VOLTAGE

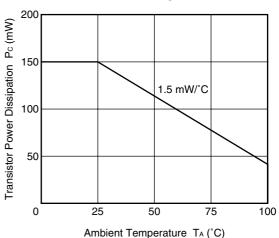


### **COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE**

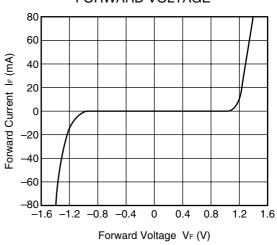


### Remark The graphs indicate nominal characteristics.

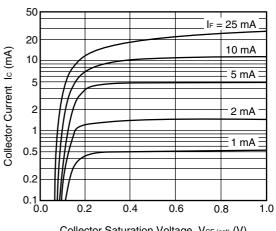
### TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



### FORWARD CURRENT vs. FORWARD VOLTAGE



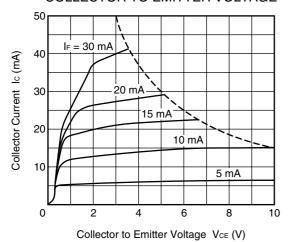
### COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**



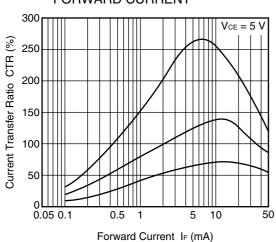
Collector Saturation Voltage VcE (sat) (V)



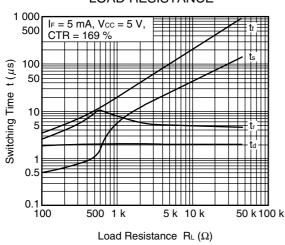
# COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



# CURRENT TRANSFER RATIO vs. FORWARD CURRENT

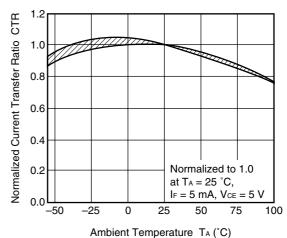


# SWITCHING TIME vs. LOAD RESISTANCE

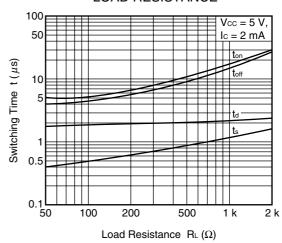


### Remark The graphs indicate nominal characteristics.

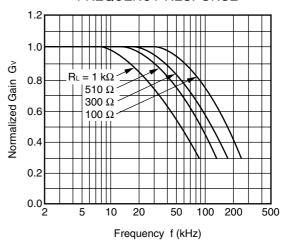
# NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



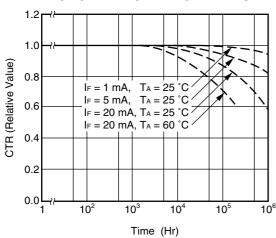
# SWITCHING TIME vs. LOAD RESISTANCE



### FREQUENCY RESPONSE



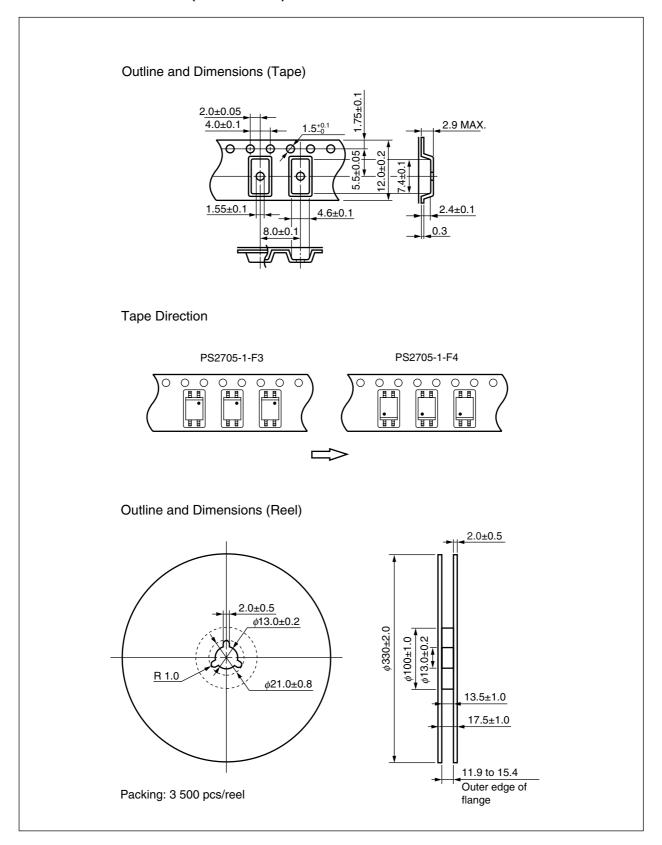
### LONG TERM CTR DEGRADATION



**Remark** The graph indicates nominal characteristics.



### **TAPING SPECIFICATIONS (in millimeters)**



### **NOTES ON HANDLING**

### 1. Recommended soldering conditions

### (1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

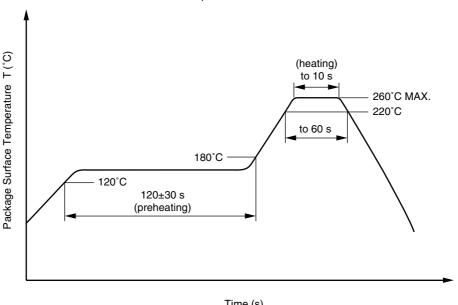
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

### Recommended Temperature Profile of Infrared Reflow



Time (s)

### (2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

### (3) Soldering by soldering iron

• Peak temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.



### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

### ★ 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below I<sub>F</sub> = 1 mA.

Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

### **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



### SPECIFICATION OF VDE MARKS LICENSE DOCUMENT (VDE0884)

| Parameter  | Symbol   | Speck            | Unit              |
|--|----------|------------------|-------------------|
| Application classification (DIN VDE 0109)  |          |                  |                   |
| for rated line voltages ≤ 300 Vr.m.s.  |          | IV               |                   |
| for rated line voltages ≤ 600 Vr.m.s.  |          | III              |                   |
| Climatic test class (DIN IEC 68 Teil 1/09.80)  |          | 55/100/21        |                   |
| Dielectric strength  |          |                  |                   |
| Maximum operating isolation voltage  | UIORM    | 710              | $V_{peak}$        |
| Test voltage (partial discharge test, procedure a for type test and random test)   | $U_pr$   | 850              | $V_{\text{peak}}$ |
| $U_{pr}=1.2\times U_{IORM},\ P_d<5\ pC$  |          |                  |                   |
| Test voltage (partial discharge test, procedure b for all devices test) $U_{pr}=1.6\times U_{\text{IORM}},\ P_{d}<5\ pC$ | Upr      | 1 140            | Vpeak             |
| Highest permissible overvoltage  | Utr      | 6 000            | V <sub>peak</sub> |
| Degree of pollution (DIN VDE 0109)   |          | 2                |                   |
| Clearance distance   |          | > 5              | mm                |
| Creepage distance  |          | > 5              | mm                |
| Comparative tracking index (DIN IEC 112/VDE 0303 part 1)   | CTI      | 175              |                   |
| Material group (DIN VDE 0109)  |          | III a            |                   |
| Storage temperature range  | Tstg     | -55 to +150      | °C                |
| Operating temperature range  | TA       | -55 to +100      | °C                |
| Isolation resistance, minimum value  |          |                  |                   |
| $V_{10}$ = 500 V dc at $T_A$ = 25 °C   | Ris MIN. | 10 <sup>12</sup> | Ω                 |
| V <sub>IO</sub> = 500 V dc at T <sub>A</sub> MAX. at least 100 °C  | Ris MIN. | 10 <sup>11</sup> | Ω                 |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve)                                |          |                  |                   |
| Package temperature  | Tsi      | 150              | °C                |
| Current (input current I <sub>F</sub> , Psi = 0)   | Isi      | 200              | mA                |
| Power (output or total power dissipation)  | Psi      | 300              | mW                |
| Isolation resistance   |          |                  |                   |
| $V_{IO}$ = 500 V dc at $T_A$ = 175 °C (Tsi)  | Ris MIN. | 10°              | Ω                 |

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M8E 00.4-0110



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  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

### ▶ For further information, please contact

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